CD74FCT573, CD74FCT573AT

Data sheet acquired from Harris Semiconductor SCHS260A

## BiCMOS FCT Interface Logic,

 Octal Transparent Latches, Three-State
## Description

The CD74FCT573 and CD74FCT573AT octal transparent latches use a small geometry BiCMOS technology. The output stage is a combination of bipolar and CMOS transistors that limits the output HIGH level to two diode drops below $\mathrm{V}_{\mathrm{CC}}$. This resultant lowering of output swing ( 0 V to 3.7 V ) reduces power bus ringing (a source of EMI) and minimizes $\mathrm{V}_{\mathrm{CC}}$ bounce and ground bounce and their effects during simultaneous output switching. The output configuration also enhances switching speed and is capable of sinking 48 milliamperes.

The CD74FCT573 and CD74FCT573AT outputs are transparent to the inputs when the Latch Enable (LE) is HIGH. When the Latch Enable ( $\overline{\mathrm{LE}}$ ) goes LOW, the data is latched. The Output Enable ( $\overline{\mathrm{OE}}$ ) controls the three-state outputs. When the Output Enable ( $\overline{\mathrm{OE})}$ ) is HIGH, the outputs are in the high impedance state. The latch operation is independent of the state of the Output Enable.

## Ordering Information

| PART NUMBER | TEMP. <br> RANGE $\left({ }^{\circ} \mathbf{C}\right)$ | PACKAGE | PKG. <br> NO. |
| :--- | :---: | :--- | :--- |
| CD74FCT573ATE | 0 to 70 | 20 Ld PDIP | E20.3 |
| CD74FCT573M | 0 to 70 | 20 Ld SOIC | M20.3 |
| CD74FCT573SM | 0 to 70 | 20 Ld SSOP | M20.209 |

NOTE: When ordering the suffix M and SM packages, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.

## Pinout

CD74FCT573, CD74FCT573AT
(PDIP, SOIC, SSOP)


## Functional Diagram



TRUTH TABLE (Note 1)

| OUTPUT <br> ENABLE | LATCH <br> ENABLE | DATA | OUTPUT |
| :---: | :---: | :---: | :---: |
| L | H | H | H |
| L | H | L | L |
| L | L | I | L |
| L | L | h | H |
| H | X | X | Z |

NOTE:

1. $\mathrm{H}=\mathrm{HIGH}$ Voltage Level

L = LOW Voltage Level
I = Low voltage level one set up time prior to the high to low latch enable transition.
$h=$ High voltage level one set up time prior to the high to low latch enable transition.
X = Irrelevant
$\mathrm{Z}=$ High Impedance

## IEC Logic Symbol

CD74FCT573, CD74FCT573AT


## Absolute Maximum Ratings

DC Supply Voltage (VCC) . . . . . . . . . . . . . . . . . . . . . . . . -0.5 V to 6 V
DC Input Diode Current, $\mathrm{I}_{\mathrm{IK}}\left(\right.$ For $\mathrm{V}_{\mathrm{I}}<-0.5 \mathrm{~V}$ ) . . . . . . . . . . . . . -20mA
DC Output Diode Current, I $\mathrm{I}_{\mathrm{OK}}$ (for $\mathrm{V}_{\mathrm{O}}<-0.5 \mathrm{~V}$ ) $\ldots . .$.
DC Output Sink Current per Output Pin, IO . . . . . . . . . . . . . . . 70 mA
DC Output Source Current per Output Pin, IO . . . . . . . . . . . . . 30mA
DC $\mathrm{V}_{\mathrm{CC}}$ Current ( $\mathrm{I}_{\mathrm{CC}}$ ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 140 mA
DC Ground Current (IGND) .400 mA

## Thermal Information

| Thermal Resistance (Typical, Note 2) | $\theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ |
| :---: | :---: |
| PDIP Package | 135 |
| SOIC Package | 125 |
| SSOP Package | 130 |
| Maximum Junction Temperature | . $150^{\circ} \mathrm{C}$ |
| Maximum Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Maximum Lead Temperature (Soldering (SOIC and SSOP-Lead Tips Only) | $\ldots 300^{\circ} \mathrm{C}$ |

Operating Conditions

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:
2. $\theta_{J A}$ is measured with the component mounted on an evaluation PC board in free air.

Electrical Specifications Commercial Temperature Range $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}} \mathrm{Max}=5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}} \mathrm{Min}=4.75 \mathrm{~V}$ (Note 5)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | $\mathrm{V}_{\mathrm{Cc}}(\mathrm{V})$ | AMBIENT TEMPERATURE ( $\mathrm{T}_{\mathrm{A}}$ ) |  |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $25^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ TO $70^{\circ} \mathrm{C}$ |  |  |
|  |  | V (V) | I 0 (mA) |  | MIN | MAX | MIN | MAX |  |
| High Level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ |  |  |  | 4.75 to 5.25 | 2 | - | 2 | - | V |
| Low Level Input Voltage | $\mathrm{V}_{\text {IL }}$ |  |  | 4.75 to 5.25 | - | 0.8 | - | 0.8 | V |
| High Level Output Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ | -15 | Min | 2.4 | - | 2.4 | - | V |
| Low Level Output Voltage | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ | 48 | Min | - | 0.55 | - | 0.55 | V |
| High Level Input Current | IIH | $\mathrm{V}_{\mathrm{CC}}$ |  | Max | - | 0.1 | - | 1 | $\mu \mathrm{A}$ |
| Low Level Input Current | IIL | GND |  | Max | - | -0.1 | - | -1 | $\mu \mathrm{A}$ |
| Three-State Leakage Current | IOZH | $\mathrm{V}_{\text {CC }}$ |  | Max | - | 0.5 | - | 10 | $\mu \mathrm{A}$ |
|  | IOZL | GND |  | Max | - | -0.5 | - | -10 | $\mu \mathrm{A}$ |
| Input Clamp Voltage | $\mathrm{V}_{\text {IK }}$ | $V_{C C}$ or GND | -18 | Min | - | -1.2 | - | -1.2 | V |
| Short Circuit Output Current (Note 3) | IOS | $\begin{gathered} \mathrm{V}_{\mathrm{O}}=0 \\ \mathrm{~V}_{\mathrm{CC}} \text { or } \\ \mathrm{GND} \end{gathered}$ |  | Max | -60 | - | -60 | - | mA |
| Quiescent Supply Current, MSI | ${ }^{\text {c C }}$ | $V_{C C}$ or GND | 0 | Max | - | 8 | - | 80 | $\mu \mathrm{A}$ |
| Additional Quiescent Supply Current per Input Pin TTL Inputs High, 1 Unit Load | $\Delta^{\text {CC }}$ | $\begin{gathered} \hline 3.4 \mathrm{~V} \\ (\text { Note } 4) \end{gathered}$ |  | Max | - | 1.6 | - | 1.6 | mA |

NOTES:
3. Not more than one output should be shorted at one time. Test duration should not exceed 100 ms .
4. Inputs that are not measured are at $\mathrm{V}_{\mathrm{CC}}$ or GND.
5. FCT Input Loading: All inputs are 1 unit load. Unit load is $\Delta I_{\mathrm{CC}}$ limit specified in Electrical Specifications table, e.g., 1.6 mA Max. at $70^{\circ} \mathrm{C}$.

Switching Specifications Over Operating Range FCT Series $t_{r}, t_{f}=2.5 \mathrm{~ns}, C_{L}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}$ (Figure 4) (Note 6)

| PARAMETER | SYMBOL | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $25^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ TO $70^{\circ} \mathrm{C}$ |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | TYP | MIN | MAX |  |
| Propagation Delays |  |  |  |  |  |  |
| Data to Outputs |  |  |  |  |  |  |
| CD74FCT573 | $\mathrm{tPLH}^{\text {, }}$ tPHL | 5 | 5 | 1.5 | 8 | ns |
| CD74FCT573AT | tPLH , tPHL | 5 | 3.9 | 1.5 | 5.7 | ns |
| $\overline{\mathrm{LE}}$ to Outputs |  |  |  |  |  |  |
| CD74FCT573 | $\mathrm{tPLH}, \mathrm{t}_{\text {PHL }}$ | 5 | 9 | 2 | 13 | ns |
| CD74FCT573AT | tPLH , tPHL | 5 | 4.4 | 2 | 7 | ns |
| Output Enable Times CD74FCT573 | $t_{\text {PZL }}, \mathrm{t}_{\text {PZ }}$ | 5 | 7 | 1.5 | 12 | ns |
| CD74FCT573AT | $\mathrm{t}_{\text {PZL }}$, $\mathrm{t}_{\text {PZH }}$ | 5 | 6 | 1.5 | 8 | ns |
| Output Disable Times CD74FCT573 | $t_{\text {PLZ }}$, tPHZ | 5 | 6 | 1.5 | 7.5 | ns |
| CD74FCT573AT | $t_{\text {PLZ }}$, tPHZ | 5 | 4 | 1.5 | 5.8 | ns |
| Power Dissipation Capacitance | CPD (Note 7) | - | 34 | - | - | pF |
| Minimum (Valley) $\mathrm{V}_{\mathrm{OHV}}$ During Switching of Other Outputs (Output Under Test Not Switching) | $\mathrm{V}_{\mathrm{OHV}}$ <br> (Figure 1) | 5 | 0.5 | - | - | V |
| Maximum (Peak) V Other Outputs (Output Under Test Not Switching) | $V_{\text {OLP }}$ <br> (Figure 1) | 5 | 1 | - | - | V |
| Input Capacitance | $\mathrm{C}_{1}$ | - | - | - | 10 | pF |
| Three-State Output Capacitance | $\mathrm{C}_{\mathrm{O}}$ | - | - | - | 15 | pF |

NOTES:
6. 5 V : Min is at 5.25 V for $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}, \mathrm{Max}$ is at 4.75 V for $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$, Typ is at 5 V .
7. $\mathrm{C}_{\text {PD }}$, measured per flip-flop, is used to determine the dynamic power consumption. $P_{D}$ (per package) $=V_{C C} I_{C C}+\Sigma\left(V_{C C}{ }^{2} f_{I} C_{P D}+V_{O}{ }^{2} f_{O} C_{L}+V_{C C} \Delta I_{C C} D\right)$ where:
$\mathrm{V}_{\mathrm{CC}}=$ supply voltage
$\Delta \mathrm{I}_{\mathrm{CC}}=$ flow through current x unit load
$C_{L}=$ output load capacitance
D = duty cycle of input high
$f_{0}=$ output frequency
$f_{l}=$ input frequency

## Prerequisite for Switching

| PARAMETER | SYMBOL | $\mathrm{V}_{\mathrm{Cc}}(\mathrm{V})$ | $25^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}$ TO $70^{\circ} \mathrm{C}$ |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | TYP | MIN | MAX |  |
| Data to Latch Enable Setup Time | ${ }_{\text {t }}$ U | 5 <br> (Note 8) | - | 2 | - | ns |
| Data to Latch Enable Hold Time | $\mathrm{t}_{\mathrm{H}}$ | 5 | - | 1.5 | - | ns |
| Latch Enable Pulse Width CD74FCT573 | ${ }^{\text {W W }}$ | 5 | - | 6 | - | ns |
| CD74FCT573AT | ${ }^{\text {W W }}$ | 5 | - | 5 | - | ns |

NOTE:
8. 5 V : Minimum is at 4.75 V for $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$, Typical is at 5 V .

## Test Circuits and Waveforms



NOTE:
9. Pulse Generator for All Pulses: Rate $\leq 1.0 \mathrm{MHz} ; \mathrm{Z}_{\mathrm{OUT}} \leq 50 \Omega$; $\mathrm{t}_{\mathrm{f}}, \mathrm{t}_{\mathrm{r}} \leq 2.5 \mathrm{~ns}$.

FIGURE 1. TEST CIRCUIT


FIGURE 2. SETUP, HOLD, AND RELEASE TIMING


FIGURE 4. ENABLE AND DISABLE TIMING

SWITCH POSITION

| TEST | SWITCH |
| :---: | :---: |
| $\mathrm{t}_{\text {PLZ }}, \mathrm{t}_{\text {PZL }}$, Open Drain | Closed |
| $\mathrm{t}_{\text {PHZ }}, \mathrm{t}_{\mathrm{PZH}}, \mathrm{t}_{\text {PLH }}, \mathrm{t}_{\text {PHL }}$ | Open |

DEFINITIONS:
$C_{L}=$ Load capacitance, includes jig and probe
capacitance.
$R_{T}=$ Termination resistance, should be equal to $Z_{\text {OUT }}$ of the Pulse Generator.
$\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ to 3 V .
Input: $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=2.5 \mathrm{~ns}$ ( $10 \%$ to $90 \%$ ), unless otherwise specified


FIGURE 3. PULSE WIDTH


FIGURE 5. PROPAGATION DELAY

## Test Circuits and Waveforms (Continued)



NOTES:
10. $\mathrm{V}_{\mathrm{OLP}}$ is measured with respect to a ground reference near the output under test. $\mathrm{V}_{\mathrm{OHV}}$ is measured with respect to $\mathrm{V}_{\mathrm{OH}}$.
11. Input pulses have the following characteristics:
$P_{R R} \leq 1 \mathrm{MHz}, t_{r}=2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}}=2.5 \mathrm{~ns}$, skew 1 ns .
12. R.F. fixture with 700 MHz design rules required. IC should be soldered into test board and bypassed with $0.1 \mu \mathrm{~F}$ capacitor. Scope and probes require 700 MHz bandwidth.

FIGURE 6. SIMULTANEOUS SWITCHING TRANSIENT WAVEFORMS

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